

Easy Field Corporation Investor Conference

Presenter :
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Disclaimer

The presentation given in this Investor Conference may cover statements about future operational prospects. Such statements are expectations made by the Company about what will happen in the future according to information that is currently available. Although it is believed by the Company that such expectations are rational, they involve risks and uncertainties.

Due to the risks and uncertainties mentioned above, it is possible that the expected events or results will not happen. As such, the actual outcome may differ significantly from such previously made expectations. For the said difference between the actual outcome and expected conditions in the future, refer to the substantial materials provided in the Market Observation Post System. Our Company is not responsible for updating or revising related statements.

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01

Company Profile



Basic Information

Name of company

Easy Field Corporation

Ticker Symbol

6425

Date Established

August 22, 1988

Chairman

Mr. Wen-Chin Lo

President

Mr. Kuo-Lin Liu

Paid-in Capital

NTD 486,020 thousand (09/30/2022)

Number of Employees

Group-wide Total 586 (11/30/2022)

Main Scope of Operations

Production process equipment, OEM of equipment, systematic components

About EASY FIELD GROUP

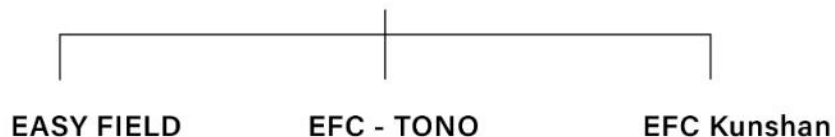
EASY FIELD



EASY FIELD GROUP

The company was founded in 1988.

Number of employees in the group : 586 people (2024/11/30)



Main business

Semiconductors,
Optoelectronics,
Biomedical,
Power batteries
Industry machine



System Frame &
OEM/ODM Service



Semiconductors,
Optoelectronics,
Biomedical,
Power batteries
Industry machine

System Frame &
OEM/ODM Service

Sunplus



Main business

Industrial plastics processing,
welding and plumbing

EFC&TONO (Kunshan)

EFC-Taoyuan (Headquarters)
TONO-Taoyuan
RI-FU Seiko-Taoyuan

TONO-Tainan

Scope of Operations

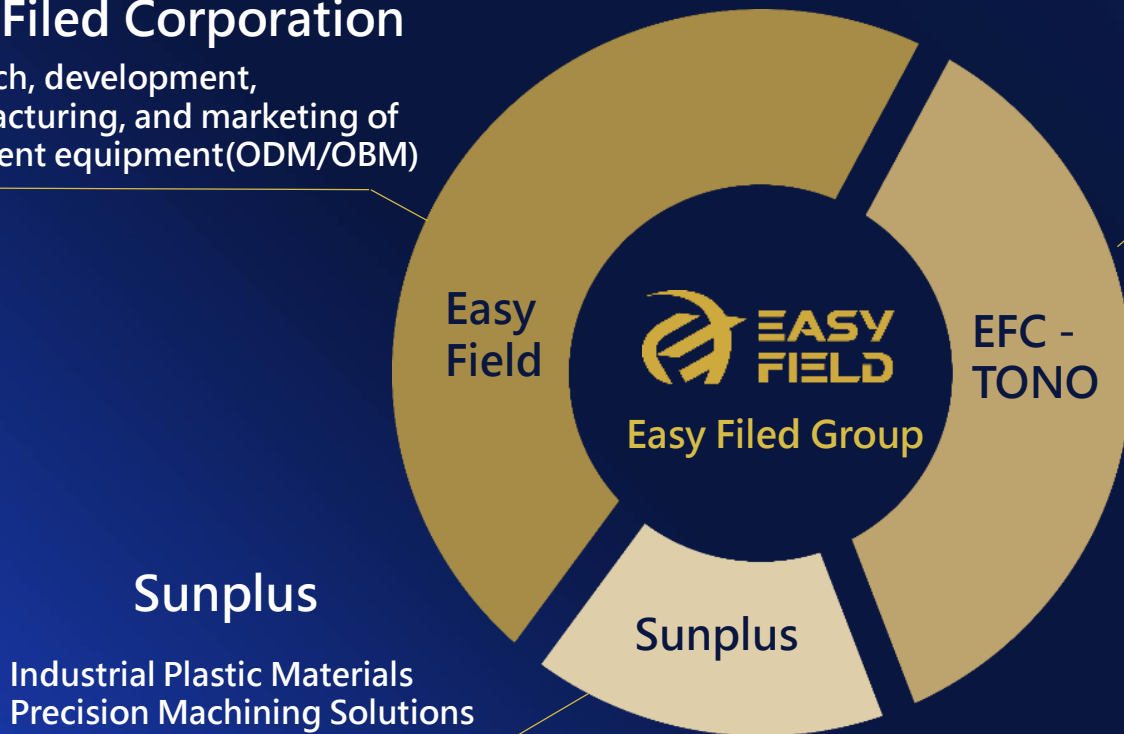
Intelligent Equipment Industry Value Chain

Easy Filed Corporation

Research, development,
manufacturing, and marketing of
intelligent equipment(ODM/OBM)

EFC - Tono

Equipment OEM and systemized
component business(OEM)



Production Process Equipment

Semi-conductor

- FOUP Auto Packer
- FOUP Auto unpacker
- FOUP Filter exchanger
- Wafer/Glass defect inspection equipment



Photoelectricity

- FOG Inline
- OCA in-Line
- OLB Bonder
- AI Sever auto Assy line



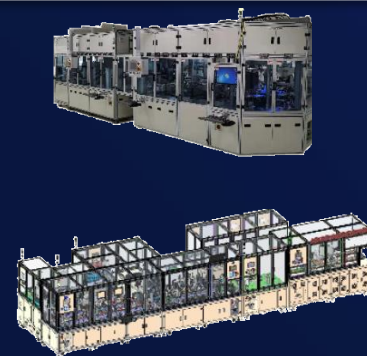
Biomedicine

- Contact lens production equipment
- Contact lens detector
- Color disposable process equipment
- Contact lens cutting equipment



Power Battery

- Cylindrical Cell Assy Line
- Prismatic Battery Fully Automated Assy Line
- Cylindrical Battery Module Automatic Line
- End-Plate Automatic Assy Line



Advanced Bonding Technology

Easy Field Corporation provides comprehensive bonding equipment solutions such as FOG, FOB, ILB, and Flip Chip, meeting the high-precision requirements of semiconductor and optoelectronic manufacturing processes

Technical
Features:

High-
precision
optical
alignment

High
throughput
and stable
cycle time

Multi-material
interconnection
capability

Full-range
temperature
and pressure
control

Modular
structural
design

Next-
generation
ILB
architecture

Optimized
key modules

Application Fields

LCD / OLED display modules, advanced semiconductor packaging processes

Implementation Benefits: Effectively enhances connection stability, reduces human-operation errors, improves yield rate, and strengthens production capacity and process consistency.

R&D and Technology

High-Precision Lamination Technology

Easy Field Corporation possesses extensive experience in the development of complete lamination equipment systems, including OCA, OCR, vacuum, water-based adhesive, and curved-surface applications

Technical
Features :

OCA Optical
Lamination
Technology

OCR (Liquid
Adhesive)
Vacuum
Lamination

Vacuum and
Curved-
Surface
Lamination
Technology

UV-Curing
Lamination
Process

Dual-Layer
Lamination
Application

Full-
Parameter
Closed-Loop
Control

Compatibility
with
Heterogeneous
Materials

Application Fields

Smartphones / Tablets / Automotive Displays / Sensors / Optocoupler Assembly / On-cell Integration / Curved Displays
Implementation Benefits : Enhances optical quality and display uniformity, reduces material defects and lamination bubble rate.

R&D and Technology

Automated Optical Inspection (AOI) Technology

Easy Field Corporation independently develops AOI systems that integrate AI algorithms, optical imaging, and motion control platforms to deliver high-speed, high-precision defect detection and automated classification.

Technical
Features :

**AI deep-
learning
vision
algorithms**

**Comprehensive
defect
inspection
for multiple
defect types**

**High-speed
scanning
and
multi-station
architecture**

**Modular
design with
flexible
applications**

**MES
integration
and data
analytics**

Application Fields

Wafer inspection and packaging AOI, optoelectronic display and panel AOI, biomedical device and contact lens inspection

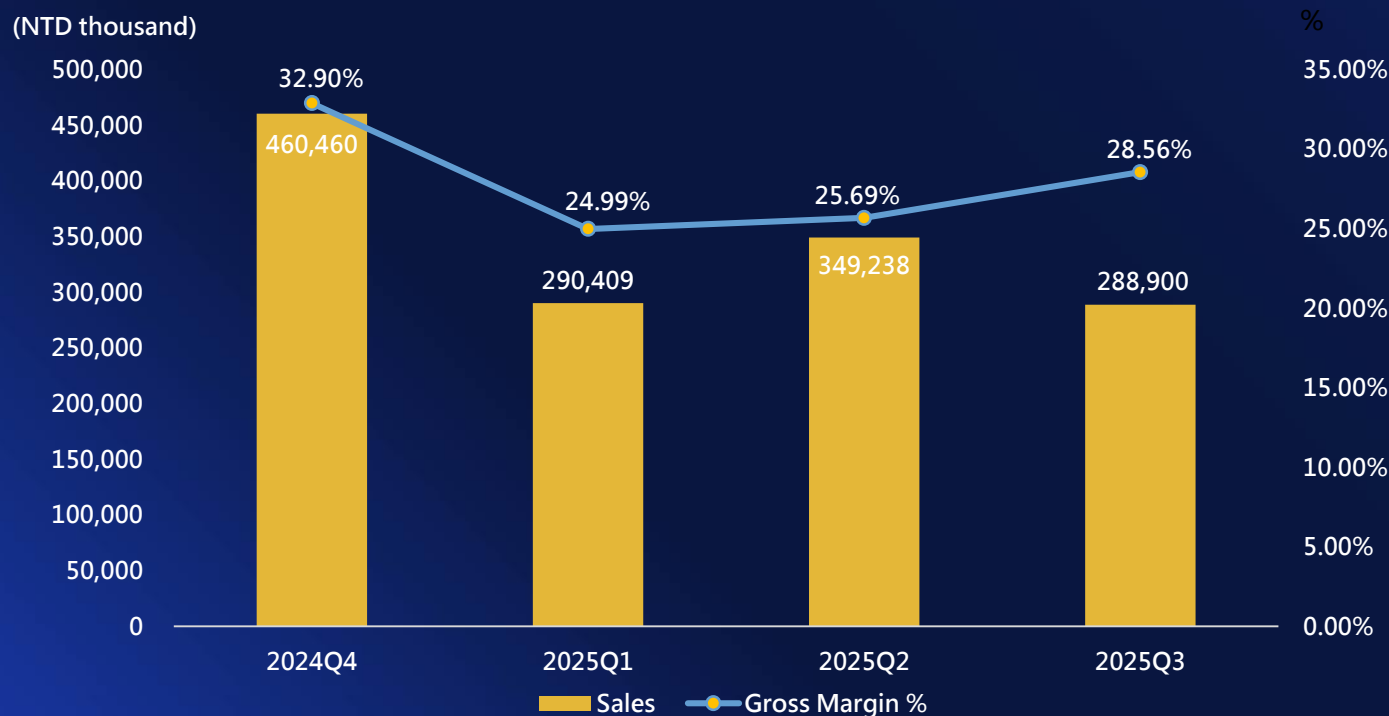
Implementation Benefits: Achieves fully automated 100% defect screening, reduces human judgment errors, improves detection rate and decision-making efficiency, and enables intelligent quality control and predictive maintenance.

02

Operating and Financial Accomplishments

Sales / Gross margin rate (past 4 quarters)

Changes in Sales and Gross margin rate



Portfolio over Past Four Quarters

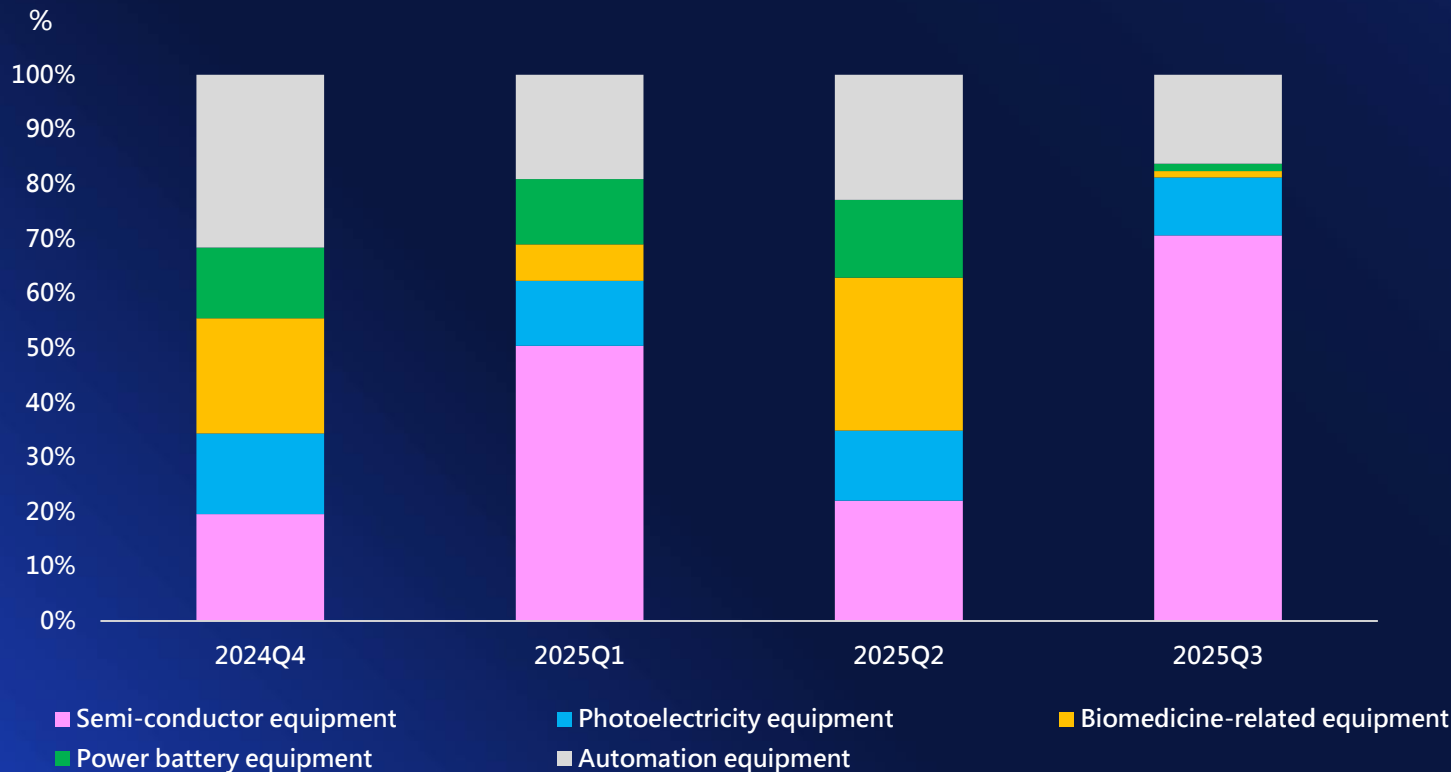
Revenue and Ratio by Product

Unit: NTD thousand; %

Main Category	2024 / Q4		2025 / Q1		2025 / Q2		2025 / Q3	
	Amout	%	Amout	%	Amount	%	Amount	%
Production process equipment	236,411	51.34	143,885	49.55	134,927	38.63	126,792	43.89
Equipment OEM	41,688	9.05	43,118	14.85	114,830	32.88	61,154	21.17
Systematic component	182,361	39.60	103,406	35.61	99,481	28.49	100,954	34.94
Total	460,460	100.00	290,409	100.00	349,238	100.00	288,900	100.00

Portfolio over Past Four Quarters

Ratio of production process equipment



Global Clients



Our Clients (By sector)

(Partial lists as belowed)

Semi Conductor



Optical



Automation



Green Energy



Comprehensive Income Statement

Comprehensive Income Statement for Past Three Years

Unit: NTD thousand; %

Item	Jan 1 to Sep 30, 2025		Jan 1 to Sep 30, 2024		2024		2023		2022	
	Amount	%	Amount	%	Amount	%	Amount	%	Amount	%
Operating revenue	928,547	100.00	1,236,539	100.00	1,696,999	100.00	1,094,633	100.00	1,597,018	100.00
Operating cost	(683,763)	(73.64)	(849,019)	(68.66)	(1,157,998)	(68.24)	(822,482)	(75.14)	(1,191,685)	(74.62)
Operating margin	244,784	26.36	387,520	31.34	539,001	31.76	272,151	24.86	405,333	25.38
Operating expenses	358,992	38.66	354,472	28.67	487,358	28.72	349,749	31.95	375,112	23.49
Net operating profit (loss)	(114,208)	(12.30)	33,048	2.67	51,643	3.04	(77,598)	(7.09)	30,211	1.89
Non-operating income and expense	(34,338)	(3.70)	217	0.02	(1,312)	(0.08)	(2,613)	(0.24)	23,010	1.44
Net profit (loss) before tax	(148,546)	(16.00)	33,265	2.69	50,331	2.97	(80,211)	(7.33)	53,231	3.33
(Expenditure) Profit from income tax	(24,859)	(2.68)	(14,996)	(1.21)	14,126	0.83	(7,740)	(0.71)	3,663	0.23
Net profit (loss) for the current term	(123,687)	(13.32)	18,299	1.48	36,205	2.14	(72,471)	(6.62)	49,568	3.10
Net profit (loss) attributable to:										
Owners of the Company	(125,451)	(13.51)	13,333	1.08	30,305	1.79	(69,213)	(6.32)	48,958	3.07
Non-controlling interests	1,764	0.19	4,966	0.40	5,900	0.35	(3,258)	(0.30)	610	0.03
Earnings (Deficits) per share										
Basic	(2.58)		0.31		0.69		(1.59)		1.12	
Diluted	(2.58)		0.31		0.69		(1.59)		1.12	

Comprehensive Balance Sheet

Comprehensive Income Statement for Past Two Years

Unit: NTD thousand; %

Item	2023.12.31		2024.12.31		2025.09.30	
	Amount	%	Amount	%	Amount	%
Total Assets	2,484,384	100	2,919,698	100	2,696,820	100
Cash and cash equivalents	264,415	11	668,090	23	514,339	19
Other current assets	955,802	38	976,465	33	884,602	33
Total current assets	1,220,217	49	1,644,555	56	1,398,941	52
Property, plant and equipment	1,007,909	41	994,011	34	1,022,518	38
Other non-current assets	256,258	10	281,132	10	275,361	10
Total non-current assets	1,264,167	51	1,275,143	44	1,297,879	48
Total liabilities	1,554,538	63	1,601,759	55	1,556,849	58
Total current liabilities	1,006,932	41	956,370	33	1,205,993	45
Total non-current liabilities	547,606	22	645,389	22	350,856	13
Total equity	929,846	37	1,317,939	45	1,139,971	42
The Net Asset Value of Each Share	19.32		26.06		22.37	

Financial analysis

Financial analysis for Past Two Years

Item		Year	Jan 1 to Sep 30, 2025	Jan 1 to Sep 30, 2024	2024	2023
Financial Structure	Debt Ratio		57.73	64.49	54.86	62.57
Debt service ability	Current Ratio		116.00	109.63	171.95	121.18
	Quick Ratio		87.50	74.90	138.58	79.28
Operating ability	Account Receivable Turnover Rate		2.20	2.66	2.93	1.96
	Inventory Turnover Rate		2.95	2.87	3.49	2.54
Profitability	Assets return ratio		(4.93)	(1.60)	2.16	(2.04)
	Equity return ratio		(13.42)	(6.78)	3.22	(7.60)
	Net profit ratio		(13.32)	12.83	2.13	(6.62)
	Earning per share		(2.58)	0.31	0.69	(1.58)

03

Q&A



Thank You !